

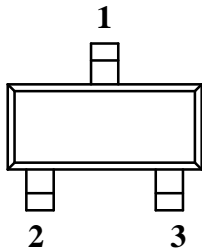
Silicon NPN Planar RF Transistor

Applications

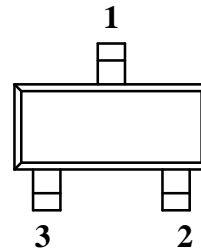
Wide band amplifier up to GHz range.

Features

- High power gain
- Low noise figure
- High transition frequency



94 9280



95 10527

BFR92A Marking
Plastic case (SOT 23)
1= Collector; 2= Base; 3= Emitter

BFR92AR Marking
Plastic case (SOT 23R)
1= Collector; 2= Base; 3= Emitter

Absolute Maximum Ratings

Parameters	Symbol	Value	Unit
Collector-base voltage	V_{CBO}	20	V
Collector-emitter voltage	V_{CEO}	15	V
Emitter-base voltage	V_{EBO}	2	V
Collector current	I_C	30	mA
Total power dissipation $T_{amb} \leq 60^\circ\text{C}$	P_{tot}	200	mW
Junction temperature	T_j	150	$^\circ\text{C}$
Storage temperature range	T_{stg}	-65 to +150	$^\circ\text{C}$

Maximum Thermal Resistance

Parameters	Symbol	Value	Unit
Junction ambient, mounted on glass fibre printed board (25 x 20 x 1.5) mm ³ , plated with 35 μm Cu	R_{thJA}	450	K/W

Electrical DC Characteristics

 $T_{amb} = 25^{\circ}\text{C}$

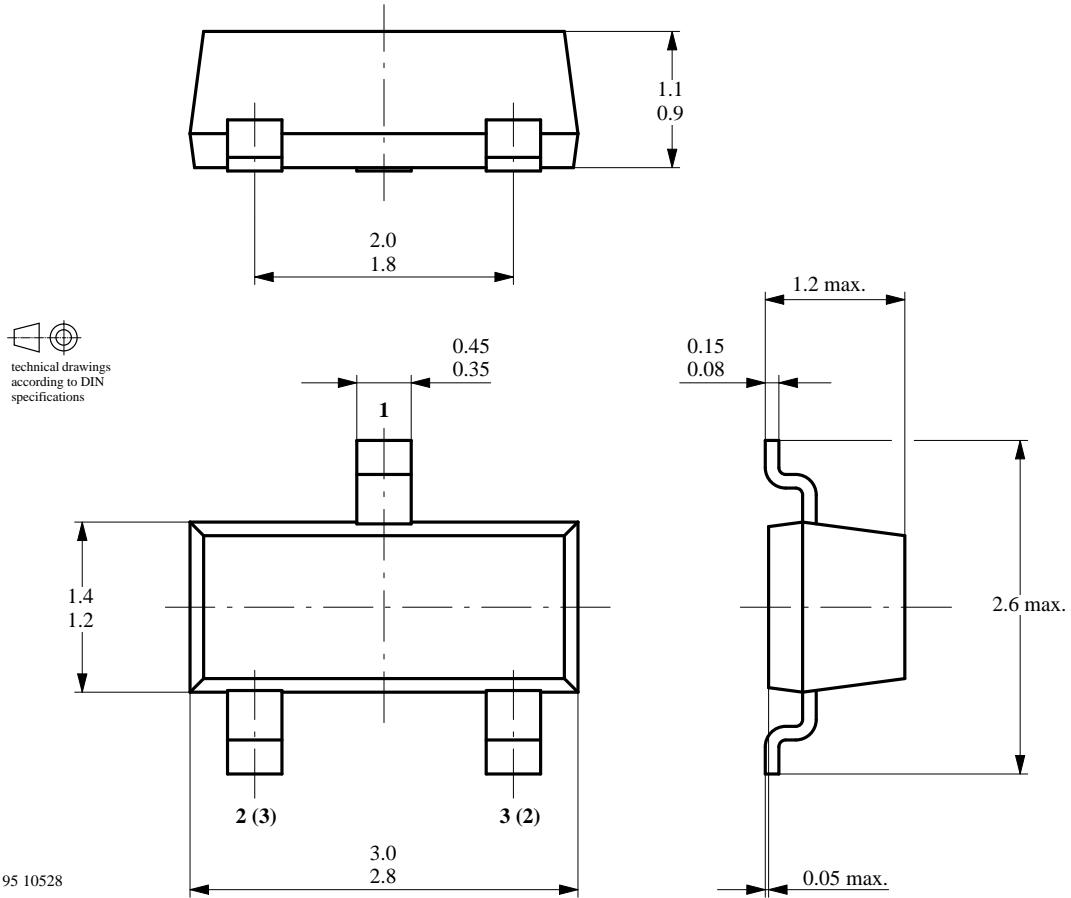
Parameters / Test Conditions	Symbol	Min.	Typ.	Max.	Unit
Collector-base cut-off current $V_{CB} = 10\text{ V}, I_E = 0\text{ A}$	I_{CBO}			50	nA
Collector-base breakdown voltage $I_C = 10\text{ }\mu\text{A}$	$V_{(BR)CBO}$	20			V
Collector-emitter breakdown voltage $I_C = 2\text{ mA}, I_B = 0\text{ A}$	$V_{(BR)CEO}$	15			V
Emitter-base breakdown voltage $I_E = 10\text{ }\mu\text{A}$	$V_{(BR)EBO}$	2			V
DC forward current transfer ratio $V_{CE} = 10\text{ V}, I_C = 14\text{ mA}$	h_{FE}	65	100	150	

Electrical AC Characteristics

 $T_{amb} = 25^{\circ}\text{C}$

Parameters / Test Conditions	Symbol	Min.	Typ.	Max.	Unit
Transition frequency $V_{CE} = 10\text{ V}, f = 500\text{ MHz}, I_C = 14\text{ mA}$	f_T	5.0	6.0		GHz
Collector-base capacitance $V_{CB} = 10\text{ V}, f = 1\text{ MHz}$	C_{cb}		0.3		pF
Collector-emitter capacitance $V_{CE} = 10\text{ V}, f = 1\text{ MHz}$	C_{ce}		0.15		pF
Emitter-base capacitance $V_{EB} = 0.5\text{ V}, f = 1\text{ MHz}$	C_{eb}		0.65		pF
Noise figure $V_{CE} = 10\text{ V}, I_C = 2\text{ mA}, R_S = 50\text{ }\Omega, f = 800\text{ MHz}$	F_e		1.8		dB
Power gain $V_{CE} = 10\text{ V}, R_S = 50\text{ }\Omega, R_L = R_{Lopt},$ $I_C = 14\text{ mA}, f = 800\text{ MHz}$	G_{pe}		16		dB
Linear output voltage – two tone intermodulation test $V_{CE} = 10\text{ V}, I_C = 14\text{ mA}, d_{IM} = 60\text{ dB},$ $f_1 = 806\text{ MHz}, f_2 = 810\text{ MHz}, R_S = R_L = 50\text{ }\Omega$	$v_1 = v_2$		120		mV
Third order intercept point $V_{CE} = 10\text{ V}, I_C = 14\text{ mA}, f = 800\text{ MHz}$	IP_3		24		dBm

Dimensions in mm



Ozone Depleting Substances Policy Statement

It is the policy of **TEMIC TELEFUNKEN microelectronic GmbH** to

1. Meet all present and future national and international statutory requirements.
2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

TEMIC TELEFUNKEN microelectronic GmbH semiconductor division has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

TEMIC can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

We reserve the right to make changes without further notice to improve technical design.

Parameters can vary in different applications. All operating parameters must be validated for each customer application by customer. Should Buyer use TEMIC products for any unintended or unauthorized application, Buyer shall indemnify TEMIC against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

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